

L Number	Hits	Search Text	DB	Time stamp
59	1	"5233871".PN.	USPAT	2003/03/04 15:36
97	396	((acceler\$6) near3 (sensor transducer)) same ((integrat\$2 near3 circuit) r IC)	USPAT; US-P PUB	2003/03/04 15:50
98	0	((acceler\$6) near3 (sensor transducer)) same ((integrat\$2 near3 circuit) or IC)) same (adhesive near3 (film or (membran\$3 near3 cover\$3) or coat\$3 or material))	USPAT; US-PGPUB	2003/03/04 15:51
99	8	((acceler\$6) near3 (sensor transducer)) same ((integrat\$2 near3 circuit) or IC)) and (adhesive near3 (film or (membran\$3 near3 cover\$3) or coat\$3 or material))	USPAT; US-PGPUB	2003/03/04 15:50
101	241	((acceler\$6) near3 (sensor transducer)) same ((integrat\$2 near3 circuit) or IC)	EPO; JPO; DERWENT	2003/03/04 15:50
102	0	((acceler\$6) near3 (sensor transducer)) same ((integrat\$2 near3 circuit) or IC)) same (adhesive near3 (film or (membran\$3 near3 cover\$3) or coat\$3 or material))	EPO; JPO; DERWENT	2003/03/04 15:51
104	1	((acceler\$6) near3 (sensor transducer)) same ((integrat\$2 near3 circuit) or IC)) and (adhesive near3 (film or (membran\$3 near3 cover\$3) or coat\$3 or material))	EPO; JPO; DERWENT	2003/03/04 15:52
106	21	((acceler\$6) near3 (sensor transducer)) same (adhesive near3 (film or (membran\$3 near3 cover\$3) or coat\$3 or material))	USPAT; US-PGPUB	2003/03/04 16:39
107	0	((acceler\$6) near3 (sensor transducer)) same (stack\$2 near3 chip)	USPAT; US-PGPUB	2003/03/04 16:12
108	0	((semiconduuctor) near3 (sensor transducer)) same (stack\$2 near3 chip)	USPAT; US-PGPUB	2003/03/04 16:14
110	2346	(stack\$2 near3 (chip or micro\$1chip))	USPAT; US-PGPUB	2003/03/04 16:14
112	3	((stack\$2 near3 (chip or micro\$1chip))) same ((semiconductor) near3 (sensor transducer))	USPAT; US-PGPUB	2003/03/04 16:15
113	4	((stack\$2 near3 (chip or micro\$1chip))) same ((semiconductor or acceler\$5) near3 (sensor transducer))	USPAT; US-PGPUB	2003/03/04 16:38
115	7	((acceler\$6 or semicoductor) near3 (sensor transducer)) same (adhesive near3 film)	USPAT; US-PGPUB	2003/03/04 16:40